



## FOR IMMEDIATE RELEASE

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## YESTech to Exhibit New F1 Series AOI and X-ray Inspection Solutions at the SMTA International 2008

### *YESTech Showcases Next Generation F1 AOI and X-Series 3-D X-Ray Systems in Booth # 216*

**San Clemente, CA – August 12, 2008** - YESTech, a leading supplier of automated optical and x-ray inspection systems for the electronics industry, will showcase the next generation YTV F1 AOI system and the X3, 3-D X-Ray inspection system - at this years' the SMTA International, held on August 17-21, Booth 216 at Disney's Coronado Springs Resort in Orlando, Florida.

The newly upgraded YTV F1-Series AOI system, delivers the most complete inspection solution to date, providing advanced inspection of solder and lead defects, component presence and position, correct part, polarity and through-hole parts. The F1-Series is ideally suited for high-volume or high mix manufacturing environments and helps to increase throughput, improve quality and reduce costs. It is equally effective for pre/post-reflow applications. The system's four advanced oblique viewing cameras offer critical inspection capabilities for R-nets and other difficult to inspect parts. YESTech's newly improved **Fusion Lighting™**, with multi-color solder joint inspection, delivers 20% higher detection capabilities when compared to previous models. The F1 Series AOI offers off-line programming and utilizes a standard package library to simplify training and ensure program portability across manufacturing lines. Real-time SPC monitoring is a standard option.

In addition, the innovative new X-Series Automated X-Ray Inspection System (AXI) offers printed circuit board assembly manufacturers advanced 3-D inspection capability for fast and complete inspection of PCBs with BGAs and other hidden solder joints. The X3's proprietary imaging technology rapidly gathers multiple oblique images of the sample to construct a 3 dimensional rendering used in identifying solder and component related defects on both single and double-sided boards. The X3's unique ability to selectively use 2-D or 3-D technology to inspect specific regions of interest on a board, provides a critical advantage of balancing double sided inspection and throughput.

"We are very excited to be showcasing our latest inspection solutions at this years SMTAI show," said YESTech president Don Miller. "It is great opportunity to meet with our clients and demonstrate the latest enhancements to the new F1-Series AOI and X3 3-D X-Ray inspection system, offering the best value in AOI and X-Ray inspection solutions."

### **Editor's Note**

A high-resolution image of the X-Series and next generation F1 Series is available by calling (949) 439-5351 or by visiting [http://www.kreativesolution.com/yestefh-smta\\_08.htm](http://www.kreativesolution.com/yestefh-smta_08.htm). For pricing and availability call YESTech's USA HQ at: 949-361-2714 or visit the YESTech website @ [www.yestechinc.com](http://www.yestechinc.com)

### **SMTA International 2008**

SMTAI attracts the perfect blend of users, suppliers, academics, and technologists. The event is the absolute location to learn and do business. The SMTA continues to be a leader in providing the industry with the best investment for technical information and networking. SMTAI's conference includes technology information, attracting companies and colleagues wanting to be their best in today's changing world. For more information visit <http://www.smta.org/smtai>

**About YESTech**

Headquartered in San Clemente, California, YESTech is a leading provider of automated optical and high-resolution x-ray inspection systems, with integrated yield enhancement solutions for the printed circuit board assembly and advanced semiconductor-packaging industries. Founded in 2002 and acquired in 2007 as a subsidiary of Nordson Corporation (Nasdaq:NDSN), YESTech is operated and managed by a team of industry experts with a history of success, bringing powerful and cost-effective inspection to the electronics market. The company has sales offices and customer support centers in North America, Asia and Europe. For more information on YESTech and its products, visit [www.yestechinc.com](http://www.yestechinc.com) For more information on Nordson Corporation visit <http://www.nordson.com>

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